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MB05S THRU MB10S

SINGLE-PHASE GLASS PASSIVATED SILICON SURFACE MOUNT BRIDGE RECTIFIER

REVERSE VOLTAGE: FORWARD CURRENT:

50 to 1000 VOLTS 1.0 AMPERE

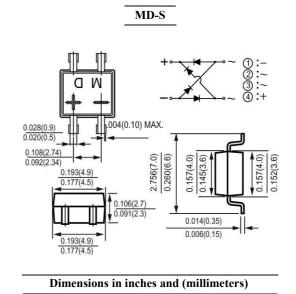
FEATURES

 \cdot Glass passivated chip junction

- \cdot Low forward voltage drop
- \cdot High surge overload rating of 50 Amperes peak
- \cdot Ideal for printed circuit board
- · High temperature soldering guaranteed:
- 260°C for 10 seconds

MECHANICAL DATA

Case: Molded plastic, DB-S Epoxy: UL 94V-O rate flame retardant Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed Mounting position: Any Weight: 0.008ounce, 0.22gram



Maximum Ratings and Electrical Characteristics

Ratings at 25℃ ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	MB05S	MB1S	MB2S	MB4S	MB6S	MB8 S	MB10S	Units
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V RMS	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at TA=40°C (Note 2)	I(AV)				1.0				Amp
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	50							Атр
Maximum Forward Voltage at 1.0A DC and 25℃	VF	1.1							Volts
Maximum Reverse Currentat TA=25°Cat Rated DC Blocking VoltageTA=125°C	I _R	5.0 500							uAmp
Typical Junction Capacitance (Note 1)	CJ	25							pF
Typical Thermal Resistance (Note 2)	Rөја	40							°C/W
Typical Thermal Resistance (Note 2)	R _{ØJL}				15				°C/W
Operating and Storage Temperature Range	TJ, Tstg			-	55 to +150)			°C

NOTES:

1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.

2- Units mounted on P.C.B. with 0.5 x 0.5" (13 x 13mm) copper pads

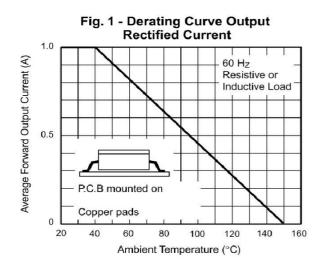


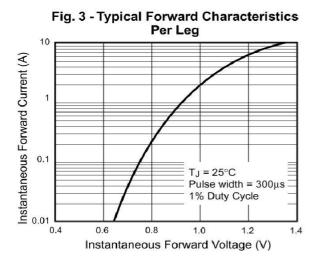
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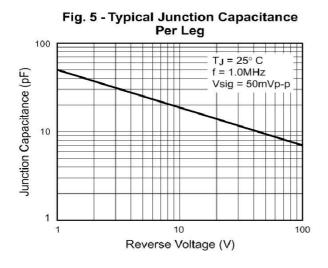
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RATINGS AND CHARACTERISTIC CURVES







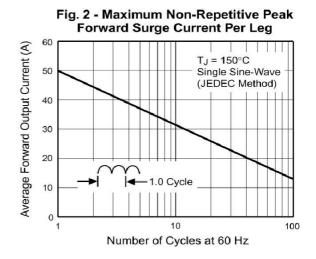


Fig. 4 - Typical Reverse Leakage Characteristics Per Leg

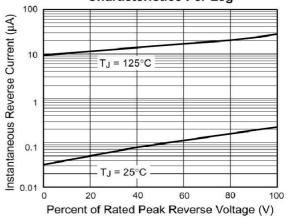


Fig. 6 - Typical Transient Thermal Impedance

